

LINEAR TECHNOLOGY MATERIALS DECLARATION

(Engineering Calculation)

TSSOP Exp. Pad

LT3845MPFE#TRPBF

(printed on: 2014-01-20 01:15:06)

TOTAL MASS (g): 0.063211

COMPONENT MATERIAL	VENDOR/INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL Pkg.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.006421	1000000	101580.171875		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.018225	975000	29365.375		
		Iron (Fe)	7439-89-6	0.000456	24000	7213.91650391		
		Phosphorus (P)	7723-14-0	0.000006	300	94.91992326		
		Zinc (Zn)	7440-66-6	0.000013	700	205.659896851		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-96-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead Frame Total:				0.019000	1000000	300579.84375
		Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0
Exter. Plating Sn	7440-31-5			0.002537	1000000	40137.78125		
External Plating Total:						0.002537	1000000	40137.78125
Inter. Plating Ni	7440-02-0			0.000000	0	0		
Inter. Plating Ag	7440-22-4			0.000250	1000000	3954.99829102		
Internal Plating Total:						0.000250	1000000	3954.99829102
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001549	750000	24505.1679688		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000516	250000	8163.11523438		
		Die Attach Total:				0.002065	1000000	32668.20125
		Encapsulation	MULTIAROMATIC RESIN BOND FREE	Resin (EP)		0.004875	150000	77122.4609375
Bromine (Br)	40093-93-8			0.000000	0	0		
Silica (SiO2)	60676-86-0			0.026650	820000	421602.78125		
Antimony Trioxide (Sb2O3)	1309-64-4			0.000000	0	0		
Metal Hydroxide				0.000813	25000	12861.653203		
Carbon Black (C)	1333-86-4			0.000163	5000	2578.65869141		
Encapsulation Total:						0.032501	1000000	514165.59375
Bond Wire Estimated	AFW/TANAKA/Kn	Gold (Au)	7440-57-5	0.000437	1000000	6913.33642578		

TOTAL MASS (g): 0.063211